

DATA SHEET

LEAD FREE CHIP RESISTORS

RC_P series ±0.5%, ±1%, ±5%

Sizes 0075/0100/0201/0402/0603/0805/ 1206/1210/1218/2010/2512



YAGEO



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SCOPE

This specification describes RC series chip resistors with made by thick film process.

<u>APPLICATIONS</u>

• All general purpose application

FEATURES

- · Total lead free without RoHS exemption
- Halogen Free Epoxy
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- MSL class: MSL I

ORDERING INFORMATION - GLOBAL PART NUMBER

Global part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

GLOBAL PART NUMBER

RC XXXX X X X XX XXXX P

(2) (3) (4) (5) (1)

(I) SIZE

0075/0100/0201/0402/0603/0805/1206/1210/1218/2010/2512

(2) TOLERANCE

 $D = \pm 0.5\%$

 $F = \pm 1.0\%$

 $J = \pm 5.0\%$ (for jumper ordering, use code of J)

(3) PACKAGING TYPE

R = Paper taping reel

K = Embossed taping reel

S = ESD safe reel (0100 only)

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Based on spec.

(5) TAPING REEL

07= 7 inch dia, Reel

13=13 inch dia. Reel

7N = 7 inch dia. Reel, ESD safe reel (0100 only)

7W = 7 inch dia. Reel & 2 x standard power

(6) RESISTANCE VALUE

There are 2~4 digits indicated the resistance value.

Letter R/K/M is decimal point.

Example:

 $97R6 = 97.6\Omega$

 $9K76 = 9760\Omega$

 $IM = 1,000,000\Omega$

(7) DEFAULT CODE

Letter P is lead free (without RoHS exemption)

ORDERING EXAMPLE

The ordering code for a RC0402 0.0625W chip resistor value $100 \mathrm{K}\Omega$ with $\pm 5\%$ tolerance, supplied in 7-inch tape reel of 10,000 units per reel is: RC0402JR-07100KP.



0075 to 2512

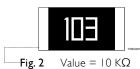
<u>MARKING</u>

RC0075 / RC0100 / RC0201 / RC0402



No Marking

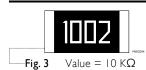
RC0603



E24 series: 3 digits, 5%

First two digits for significant figure and 3rd digit for number of zeros

RC0805 / RC1206 / RC1210 / RC1218 / RC2010 / RC2512



E24/E96 series: 4 digits, 1%, 0.5%

First three digits for significant figure and 4th digit for number of zeros

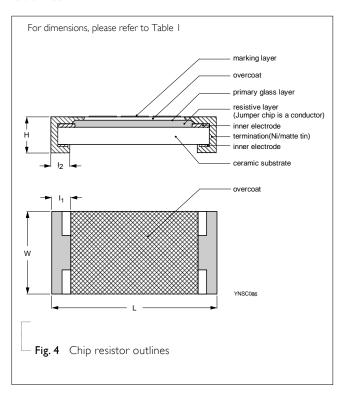
Note

For further marking information, please see special data sheet "Chip resistors marking".

CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environmental influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added, as shown in Fig.4.

Outlines





Chip Resistor Surface Mount RC_P SERIES 0075 to 2512

<u>DIMENSION</u>

Table I					
TYPE	L (mm)	W (mm)	H (mm)	I _I (mm)	I ₂ (mm)
RC0075	0.30±0.01	0.15±0.01	0.13±0.01	0.08±0.03	0.08±0.03
RC0100	0.40±0.02	0.20±0.02	0.13±0.02	0.10±0.03	0.10±0.03
RC0201	0.60±0.03	0.30±0.03	0.23±0.03	0.10±0.05	0.15±0.05
RC0402	1.00±0.05	0.50±0.05	0.35±0.05	0.20±0.10	0.25±0.10
RC0603	1.60±0.10	0.80±0.10	0.45±0.10	0.25±0.15	0.25±0.15
RC0805	2.00±0.10	1.25±0.10	0.50±0.10	0.35±0.20	0.35±0.20
RC1206	3.10±0.10	1.60±0.10	0.55±0.10	0.45±0.20	0.45±0.20
RC1210	3.10±0.10	2.60±0.15	0.55±0.10	0.45±0.15	0.50±0.20
RC1218	3.10±0.10	4.60±0.10	0.55±0.10	0.45±0.20	0.40±0.20
RC2010	5.00±0.10	2.50±0.15	0.55±0.10	0.45±0.15	0.55±0.20
RC2512	6.35±0.10	3.10±0.15	0.55±0.10	0.60±0.20	0.60±0.20

ELECTRICAL CHARACTERISTICS

Table 2

Table	Table 2							
					СНА	RACTERISTICS		
TYPE	POWER	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	RESISTANCE RANGE	Temperature Coefficient of Resistance	Jumper Criteria
RC0075	1/50W	-55°C to +125°C	10V	25V	25V	$E24 \pm 5\%$ $I0\Omega \le R \le IM\Omega$ $E24/E96 \pm I\%$ $I0\Omega \le R \le IM\Omega$ $Jumper < 50m\Omega$	10Ω≤R<100Ω:-200~+600ppm°C 100Ω≤ R≤IMΩ: ±200ppm°C	Rated Current 0.5A Max. Current 1.0A
RC0100	1/32W	-55°C to +125°C	15V	30V	30V	$E24 \pm 5\%$ $I\Omega \le R \le 10M\Omega$ $E24/E96 \pm 1\%$ $I\Omega \le R \le 10M\Omega$ $Jumper < 50m\Omega$	I Ω≤R<10Ω:-200~+600ppm°C I0Ω≤ R<100Ω: ±300ppm°C I00Ω≤R≤10MΩ: ±200ppm°C	Rated Current 0.5A Max. Current 1.0A
RC0201	1/20W	-55°C to +125°C	25V	50V	50V	$E24 \pm 5\%$ $I\Omega \leq R \leq I0M\Omega$ $E24/E96 \pm 1\%$ $I\Omega \leq R \leq I0M\Omega$ $E24/E96 \pm 0.5\%$ $I0\Omega \leq R \leq IM\Omega$ $Jumper \leq 50m\Omega$	IΩ≤R≤I0Ω: -100~+350ppm°C I0Ω <r≤i0mω: th="" ±200ppm°c<=""><th>Rated Current 0.5A Max. Current 1.0A</th></r≤i0mω:>	Rated Current 0.5A Max. Current 1.0A



Chip Resistor Surface Mount RC_P SERIES 0075 to 2512

		CHARACTERISTICS						
TYPE	POWER	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	RESISTANCE RANGE	Temperature Coefficient of Resistance	Jumper Criteria
RC0402	1/16W	-55°C to +155°C	50V	100V	100V	$\begin{aligned} & & \text{E24} \pm 5\% \\ & \text{I} \Omega \leq \text{R} \leq 22\text{M}\Omega \\ & & \text{E24/E96} \pm 1\% \\ & \text{I} \Omega \leq \text{R} \leq 10\text{M}\Omega \\ & & \text{E24/E96} \pm 0.5\% \\ & \text{I} 0\Omega \leq \text{R} \leq 1\text{M}\Omega \\ & \text{Jumper} < 50\text{m}\Omega \end{aligned}$	ΙΩ≤R≤Ι0Ω: ±200ppm°C Ι0Ω <r≤ι0μω: ±100ppm°c<br="">Ι0ΜΩ<r≤22μω: th="" ±200ppm°c<=""><th>Rated Current I.0A Max. Current 2.0A</th></r≤22μω:></r≤ι0μω:>	Rated Current I.0A Max. Current 2.0A
	1/8VV	-55°C to +155°C	50V	100V	100V	$E24 \pm 5\%$ $I\Omega \le R \le I0M\Omega$ $E24/E96 \pm I\%$ $I\Omega \le R \le I0M\Omega$	IΩ≤R≤I0Ω: ±200ppm°C I0Ω <r≤i0mω: td="" ±100ppm°c<=""><td>_</td></r≤i0mω:>	_
RC0603	1/10VV	-55°C to +155°C	75V	150V	150V	$\begin{aligned} & \text{E24} \pm 5\% \\ & \text{I} \Omega \leq \text{R} \leq 22\text{M}\Omega \\ & \text{E24/E96} \pm 1\% \\ & \text{I} \Omega \leq \text{R} \leq 10\text{M}\Omega \\ & \text{E24/E96} \pm 0.5\% \\ & \text{I} 0\Omega \leq \text{R} \leq 1\text{M}\Omega \\ & \text{Jumper} < 50\text{m}\Omega \end{aligned}$	ΙΩ≤R≤Ι0Ω: ±200ppm°C Ι0Ω <r≤ι0μω: ±100ppm°c<br="">Ι0ΜΩ<r≤22μω: th="" ±200ppm°c<=""><th>Rated Current I.0A Max. Current 2.0A</th></r≤22μω:></r≤ι0μω:>	Rated Current I.0A Max. Current 2.0A
	1/5W	-55°C to +155°C	75V	150V	150V	$E24 \pm 5\%$ $I\Omega \le R \le 10M\Omega$ $E24/E96 \pm 1\%$ $I\Omega \le R \le 10M\Omega$	IΩ≤R≤I0Ω: ±200ppm°C I0Ω <r≤i0mω: td="" ±i00ppm°c<=""><td></td></r≤i0mω:>	
RC0805	1/8\	-55°C to +155°C	150V	300V	300V	$\begin{aligned} & \text{E24} \pm 5\% \\ & \text{I}\Omega \leq \text{R} \leq 22\text{M}\Omega \\ & \text{E24/E96} \pm 1\% \\ & \text{I}\Omega \leq \text{R} \leq 10\text{M}\Omega \\ & \text{E24/E96} \pm 0.5\% \\ & \text{I}0\Omega \leq \text{R} \leq 1\text{M}\Omega \\ & \text{Jumper} < 50\text{m}\Omega \end{aligned}$	ΙΩ≤R≤Ι0Ω: ±200ppm°C Ι0Ω <r≤ι0μω: ±100ppm°c<br="">Ι0ΜΩ<r≤22μω: th="" ±200ppm°c<=""><th>Rated Current 2.0A Max. Current 5.0A</th></r≤22μω:></r≤ι0μω:>	Rated Current 2.0A Max. Current 5.0A
	1/4W	-55°C to +155°C	150V	300V	300V	$\begin{aligned} & \text{E24} \pm 5\% \\ & \text{I} \ \Omega \leq \text{R} \leq \text{IOM} \Omega \\ & \text{E24/E96} \pm \text{I}\% \\ & \text{I} \ \Omega \leq \text{R} \leq \text{IOM} \Omega \end{aligned}$	IΩ≤R≤I0Ω: ±200ppm°C I0Ω <r≤i0mω: td="" ±100ppm°c<=""><td>-</td></r≤i0mω:>	-
RC1206	I/4W	-55°C to +155°C	200V	400V	500V	$\begin{aligned} & \text{E24} \pm 5\% \\ & \text{I}\Omega \leq \text{R} \leq 22\text{M}\Omega \\ & \text{E24/E96} \pm 1\% \\ & \text{I}\Omega \leq \text{R} \leq 10\text{M}\Omega \\ & \text{E24/E96} \pm 0.5\% \\ & \text{I}0\Omega \leq \text{R} \leq 1\text{M}\Omega \\ & \text{Jumper} < 50\text{m}\Omega \end{aligned}$	ΙΩ≤R≤Ι0Ω: ±200ppm°C Ι0Ω <r≤ι0μω: ±100ppm°c<br="">Ι0ΜΩ<r≤22μω: th="" ±200ppm°c<=""><th>Rated Current 2.0A Max. Current 10.0A</th></r≤22μω:></r≤ι0μω:>	Rated Current 2.0A Max. Current 10.0A
	1/2W	-55°C to +155°C	200V	400V	500V	$\begin{aligned} & \text{E24} \pm 5\% \\ & \text{I}\Omega \leq \text{R} \leq \text{IOM}\Omega \\ & \text{E24/E96} \pm \text{I}\% \\ & \text{I}\Omega \leq \text{R} \leq \text{IOM}\Omega \end{aligned}$	IΩ≤R≤I0Ω: ±200ppm°C I0Ω <r≤i0mω: td="" ±i00ppm°c<=""><td></td></r≤i0mω:>	



Chip Resistor Surface Mount RC_P SERIES 0075 to 2512

TYPE	POWER	Operating Temperature Range	Max. Working Voltage	Max. Overload Voltage	Dielectric Withstanding Voltage	RESISTANCE RANGE	Temperature Coefficient of Resistance	Jumper Criteria
RC1210	1/2W	-55°C to +155°C	200V	500V	500V	$E24 \pm 5\%$ $I\Omega \leq R \leq 22M\Omega$ $E24/E96 \pm 1\%$ $I\Omega \leq R \leq I0M\Omega$ $E24/E96 \pm 0.5\%$ $I0\Omega \leq R \leq IM\Omega$ $Jumper \leq 50m\Omega$	IΩ≤R≤I0Ω: ±200ppm°C I0Ω <r≤i0mω: ±100ppm°c<br="">I0MΩ<r≤22mω: th="" ±200ppm°c<=""><th>Rated Current 2.0A Max. Current 10.0A</th></r≤22mω:></r≤i0mω:>	Rated Current 2.0A Max. Current 10.0A
RC1218	IW	-55°C to +155°C	200V	500∨	500V	$E24 \pm 5\%$ $I\Omega \le R \le IM\Omega$ $E24/E96 \pm 1\%$ $I\Omega \le R \le IM\Omega$ $E24/E96 \pm 0.5\%$ $I0\Omega \le R \le IM\Omega$ $Jumper < 50m\Omega$	ΙΩ≤R≤ΙΟΩ: ±200ppm°C ΙΟΩ <r≤ιμω: th="" ±ι00ppm°c<=""><th>Rated Current 6.0A Max. Current 10.0A</th></r≤ιμω:>	Rated Current 6.0A Max. Current 10.0A
RC2010	3/4W	-55°C to +155°C	200V	500V	500V	$\begin{aligned} & \text{F24} \pm 5\% \\ & \text{I}\Omega \leq \text{R} \leq 22\text{M}\Omega \\ & \text{E24/E96} \pm \text{I}\% \\ & \text{I}\Omega \leq \text{R} \leq \text{I}\text{OM}\Omega \\ & \text{E24/E96} \pm 0.5\% \\ & \text{I}0\Omega \leq \text{R} \leq \text{I}\text{M}\Omega \\ & \text{Jumper} < 50\text{m}\Omega \end{aligned}$	ΙΩ≤R≤Ι0Ω: ±200ppm°C Ι0Ω <r≤ι0μω: ±100ppm°c<br="">Ι0ΜΩ<r≤22μω: th="" ±200ppm°c<=""><th>Rated Current 2.0A Max. Current 10.0A</th></r≤22μω:></r≤ι0μω:>	Rated Current 2.0A Max. Current 10.0A
RC2512	IW	-55°C to +155°C	200V	500V	500V	$E24 \pm 5\%$ $I\Omega \le R \le 22M\Omega$ $E24/E96 \pm 1\%$ $I\Omega \le R \le I0M\Omega$ $E24/E96 \pm 0.5\%$ $I0\Omega \le R \le IM\Omega$ $Jumper < 50m\Omega$	ΙΩ≤R≤Ι0Ω: ±200ppm°C Ι0Ω <r≤ι0μω: ±100ppm°c<br="">Ι0ΜΩ<r≤22μω: th="" ±200ppm°c<=""><th>Rated Current 2.0A Max. Current 10.0A</th></r≤22μω:></r≤ι0μω:>	Rated Current 2.0A Max. Current 10.0A

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting"

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	RC0075	RC0100	RC0201	RC0402	RC0603	RC0805	RC1206	RC1210	RC1218	RC2010	RC2512
Paper taping reel (R)	7" (178 mm)		20,000	10,000	10,000	5,000	5,000	5,000	5,000			
	13" (330 mm)		80,000	50000	50000	20000	20000	20000	20000			
ESD safe reel (S)	7" (178 mm)	20,000	40,000									
Embossed taping ree	el 7" (178 mm)									4,000	4,000	4,000

NOTE

For tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

RC0402 to RC2512 Range: -55°C to +155°C (Fig. 5-1) RC0075 to RC0201 Range: -55°C to +125°C (Fig. 5-2)

POWER RATING

Each type rated power at 70 °C:

RC0075=1/50W

RC0100=1/32W

RC0201=1/20 W

RC0402=1/16 W, 1/8W

RC0603=1/10W, 1/5W

1/4W RC0805=1/8W,

RC1206=1/4W, 1/2W

RC1210=1/2W

RC1218=1W

RC2010=3/4W

RC2512=1W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(PxR)}$$

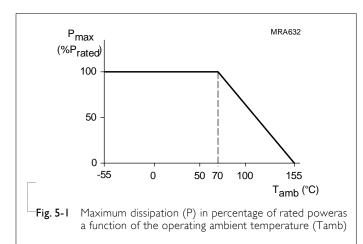
or max. working voltage whichever is less

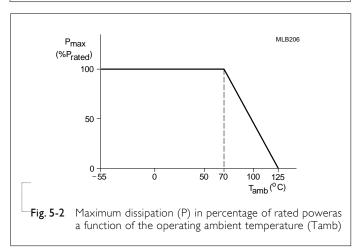
Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$







0075 to 2512

TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of	MIL-STD-202 Method 304	At +25/–55 °C and +25/+125 °C	Refer to table 2
Resistance (T.C.R.)		Formula: T.C.R= $\frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t_1 =+25 °C or specified room temperature t_2 =-55 °C or +125 °C test temperature R_1 =resistance at reference temperature in ohms R_2 =resistance at test temperature in ohms	
Life/ Endurance	MIL-STD-202G Method 108 IEC 60115-1 7.1	At 70±5°C for 1,000 hours; RCWV applied for 1.5 hours on and 0.5 hour off, still air required	0075 : $\pm (5\% + 100 \text{m}\Omega)$ < $100 \text{m}\Omega$ for jumper 0100 : $\pm (3\% + 0.05\Omega)$ Others: $\pm (1\% + 0.05\Omega)$ for D/F tol $\pm (3\% + 0.05\Omega)$ for J tol < 100mR for jumper
High Temperature Exposure	MIL-STD-202G Method 108	I,000 hours at maximum operating temperature depending on specification, unpowered.	0075 : $\pm (5\% + 100 \text{m}\Omega)$ < $100 \text{m}\Omega$ for jumper 0100 : $\pm (1\% + 0.05\Omega)$ Others: $\pm (1\% + 0.05\Omega)$ for D/F tol $\pm (2\% + 0.05\Omega)$ for J tol < 50mR for jumper
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts	0075 : $\pm (2\% + 100 \text{m}\Omega)$ < $100 \text{m}\Omega$ for jumper 0100 : $\pm (2\% + 0.05\Omega)$ Others: $\pm (0.5\% + 0.05\Omega)$ for D/F tol $\pm (2\% + 0.05\Omega)$ for J tol < 100mR for jumper
Humidity	IEC 60115-1 10.4	Steady state for 1000 hours at 40 °C / 95% R.H. RCWV applied for 1.5 hours on and 0.5 hour off	$0075: \pm (5\% + 100 \text{m}\Omega)$ $0100: \pm (3\% + 0.05\Omega)$ Others: $\pm (1\% + 0.05\Omega) \text{ for D/F tol}$ $\pm (2\% + 0.05\Omega) \text{ for J tol}$ < 100 mR for jumper
Thermal Shock	MIL-STD-202G Method 107	-55/+125°C Note Number of cycles required is 300 Devices mounted Maximum transfer time is 20 seconds Dwell time is 15 minutes. Air - Air	0075/01005: \pm (1% +50m Ω) < 50m Ω for jumper Others: \pm (0.5%+0.05 Ω) for D/F tol \pm (1%+0.05 Ω) for J tol <50mR for jumper

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Short Time Overload	IEC 60115-1 8.1	2.5 times RCWV or maximum overload voltage which is less for 5 seconds at room temperature	0075/01005: \pm (2% +50m Ω) < 50m Ω for jumper Others: \pm (1%+0.05 Ω) for D/F tol \pm (2%+0.05 Ω) for J tol <50mR for jumper
Board Flex/ Bending	IEC 60115-1 9.8	Device mounted or as described only I board bending required bending time: 60±5 seconds 0075/0100/0201/0402:5mm; 0603/0805:3mm; 1206 and above:2mm	\pm (1% +50m Ω) < 50m Ω for jumper No visible damage
Solderability - Wetting	J-STD-002 test BI	Electrical Test not required Magnification 50X SMD conditions: Ist step: aging 4 hours at 155°C dry heat 2nd step: method BI, leadfree solder bath at 245±3°C Dipping time: 3± 0.5 seconds	Well tinned (>95% covered) No visible damage
-Leaching	J-STD-002 test D	Leadfree solder ,260°C, 30 seconds immersion time	No visible damage
-Resistance to Soldering Heat	MIL-STD-202 Method 210	Condition B, no pre-heat of samples Leadfree solder, 260 °C \pm 5°C, 10 \pm 1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	0075 : $\pm(3\%+50\text{m}\Omega)$ $<50\text{m}\Omega$ for jumper 0100 : $\pm(1\%+0.05\Omega)$ Others: $\pm(0.5\%+0.05\Omega)$ for D/F tol $\pm(1\%+0.05\Omega)$ for J tol <50mR for jumper No visible damage



Chip Resistor Surface Mount RC_P SERIES 0075 to 2512

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 5	Sep. 21, 2022	-	- Add size 0075
Version 4	May. 10, 2022	-	- Extend the range of size 01005 to 10Mohm
Version 3	Oct. 12, 2021	-	- Upgrade Temperature Coefficient of Resistance
Version 2	Mar. 25, 2021	-	- Add size 01005 and Double Power for size 0402~1206
Version I	Sep. 05, 2018	-	- Remove size 01005 of this specification
Version 0	Aug. 22, 2014	-	- First issue of this specification



RC_P

SERIES

0075 to 2512

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